



JAE Electronics, Inc.
November 16th, 2017

ENG-E17-135 – Distributors (Heilind, Mouser, Digikey)

PCN (Process Change Notice)

MX44002SF1

MX44004SF1

MX44006SF1

Modified Mold Dies

(A) to (A,B,C,D)

Part Number	Existing Mold Dies (3 changing mold dies) with 1 cavity	Modified Mold Dies (3 changing mold die)	Modified Mold Dies Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX44002SF1 MX44004SF1 MX44006SF1	A	(A,B,C,D)	Beginning of December 2017	Beginning of December 2017	12/15/17 (after all PPAP approved From all Customers)

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)

- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
2. If you need PC PPAP documents, please notify us no later than **11/17/17** in order for factory to prepare and submit by the proposed time.